

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Jun-Min Yang</td> <td>11/15/2012</td> </tr> <tr> <td>Hao-Chun Hsieh</td> <td>11/15/2012</td> </tr> <tr> <td>Hsin-Lun Tsai</td> <td>11/16/2012</td> </tr> <tr> <td>Chia-Hsien Lee</td> <td>11/15/2012</td> </tr> </tbody> </table>		Name	Execution Date	Jun-Min Yang	11/15/2012	Hao-Chun Hsieh	11/15/2012	Hsin-Lun Tsai	11/16/2012	Chia-Hsien Lee	11/15/2012
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>Wistron Corporation</td> </tr> <tr> <td>Street Address:</td> <td>21F, 88, Sec. 1, Hsin-Tai-Wu Rd., Xizhi Dist.</td> </tr> <tr> <td>City:</td> <td>New Taipei City</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> </table>		Name:	Wistron Corporation	Street Address:	21F, 88, Sec. 1, Hsin-Tai-Wu Rd., Xizhi Dist.	City:	New Taipei City	State/Country:	TAIWAN		
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<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13754914</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13754914						
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CORRESPONDENCE DATA											
Fax Number: 7039974517 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 3027291562 Email: Patent.admin.uspto.cr@naipo.com Correspondent Name: WINSTON HSU Address Line 1: P.O.BOX 506 Address Line 4: Merrifield, VIRGINIA 22116											
ATTORNEY DOCKET NUMBER:	WISP0338USA1										
NAME OF SUBMITTER:	SHELLEY KUO										
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**COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION
USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT**

Title of Invention:

METHOD FOR ASSEMBLING COMPONENTS ON A CIRCUIT BOARD

As the below named inventor, I hereby declare that:
This declaration is directed to:

☒ The attached application, or

☐ United States application number _____ filed on _____, or

☐ PCT international application number _____ filed on _____

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

In consideration of the payment by Wistron Corporation having a postal address of
21F, 88, Sec. 1, Hsin-Tai-Wu Rd., Xizhi Dist., New Taipei City 221, Taiwan, R.O.C.

(referred to as "ASSIGNEE" below) to I of the sum of One Dollar (\$ 1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.

I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal

representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I have hereunto set hand and seal this 14/5/12 (Date of signing)

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for each additional inventor.

Docket No WISP0338USA1

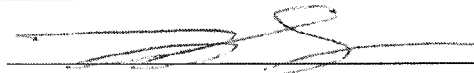
LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Jun-Min Yang**

Date:

11/15/2012

Signature:



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Docket No WISP0338USA1

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Hao-Chun Hsieh**

Date:

1/15/2012

Signature:

Hao-Chun Hsieh

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representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.
IN WITNESS WHEREOF, I have hereunto set hand and seal this 2012.11.16 (Date of signing)

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Docket No WISP0338USA1

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: Hsin-Lun Tsai

Date: 2012.11.16

Signature: Hsin-Lun Tsai 蔡倫信

NPO#WIS-P0338-USA:1
CUST#PWIH-TT-0051-USD1

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F#NPO-P0002E-US1201
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PATENT
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Docket No WISP0338USA1

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Chia-Hsien Lee**

Date: 2012/11/15

Signature: Chia-Hsien Lee

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CUST#PWIH-IT-0051-USDI

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RECORDED: 01/31/2013

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